

IV2Q12030D7Z – 1200V 30mΩ Gen2 Automotive SiC MOSFET

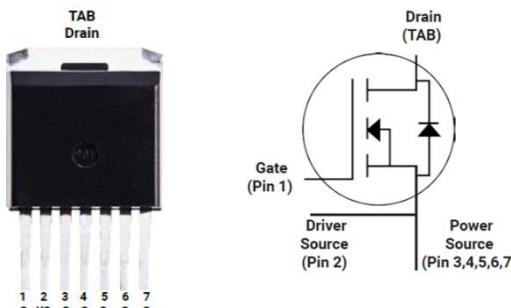
Features

- 2nd Generation SiC MOSFET Technology with +18V gate drive
- High blocking voltage with low on-resistance
- High speed switching with low capacitance
- High operating junction temperature capability
- Very fast and robust intrinsic body diode
- Kelvin gate input easing driver circuit design

Applications

- Motor drivers
- Solar inverters
- Automotive DC/DC converters
- Automotive compressor inverters
- Switch mode power supplies

Outline:



TO263-7

Marking Diagram:

YYWWZ
XXXX
2Q12030D7Z

2Q12030D7Z = Specific Device Code
 YY = Year
 WW = Work Week
 Z = Assembly Location
 XXXX = Lot Traceability

Absolute Maximum Ratings ($T_c=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Value	Unit	Test Conditions	Note
V_{DS}	Drain-Source voltage	1200	V	$V_{GS}=0\text{V}$, $I_D=100\mu\text{A}$	
$V_{GS\max}(\text{DC})$	Maximum DC voltage	-5 to 20	V	Static (DC)	
$V_{GS\max}(\text{Spike})$	Maximum spike voltage	-10 to 23	V	Duty cycle<1%, and pulse width<200ns	
$V_{GS\text{on}}$	Recommended turn-on voltage	18 ± 0.5	V		
$V_{GS\text{off}}$	Recommended turn-off voltage	-3.5 to -2	V		
I_D	Drain current (continuous)	79	A	$V_{GS}=18\text{V}$, $T_c=25^\circ\text{C}$	Fig. 23
		58	A	$V_{GS}=18\text{V}$, $T_c=100^\circ\text{C}$	
I_{DM}	Drain current (pulsed)	198	A	Pulse width limited by SOA	Fig. 26
P_{TOT}	Total power dissipation	395	W	$T_c=25^\circ\text{C}$	Fig. 24
T_{stg}	Storage temperature range	-55 to 175	°C		
T_J	Operating junction temperature	-55 to 175	°C		
T_L	Solder Temperature	260	°C	wave soldering only allowed at leads, 1.6mm from case for 10 s	

Thermal Data

Symbol	Parameter	Value	Unit	Note
$R_{\theta(J-C)}$	Thermal Resistance from Junction to Case	0.38	°C/W	Fig. 23

Electrical Characteristics ($T_c=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Value			Unit	Test Conditions	Note		
		Min.	Typ.	Max.					
I_{DSS}	Zero gate voltage drain current		5	100	μA	$V_{DS}=1200\text{V}, V_{GS}=0\text{V}$			
I_{GSS}	Gate leakage current			± 100	nA	$V_{DS}=0\text{V}, V_{GS}=-5\text{~}20\text{V}$			
V_{TH}	Gate threshold voltage	1.8	2.8	4.5	V	$V_{GS}=V_{DS}, I_D=12\text{mA}$	Fig. 8, 9		
			2.0			$V_{GS}=V_{DS}, I_D=12\text{mA}$ $@ T_J=175^\circ\text{C}$			
R_{ON}	Static drain-source on-resistance		30	39	$\text{m}\Omega$	$V_{GS}=18\text{V}, I_D=30\text{A}$ $@ T_J=25^\circ\text{C}$	Fig. 4, 5, 6, 7		
			55		$\text{m}\Omega$	$V_{GS}=18\text{V}, I_D=30\text{A}$ $@ T_J=175^\circ\text{C}$			
			36	47	$\text{m}\Omega$	$V_{GS}=15\text{V}, I_D=30\text{A}$ $@ T_J=25^\circ\text{C}$			
			58		$\text{m}\Omega$	$V_{GS}=15\text{V}, I_D=30\text{A}$ $@ T_J=175^\circ\text{C}$			
C_{iss}	Input capacitance		3000		pF	$V_{DS}=800\text{V}, V_{GS}=0\text{V},$ $f=1\text{MHz}, V_{AC}=25\text{mV}$	Fig. 16		
C_{oss}	Output capacitance		140		pF				
C_{rss}	Reverse transfer capacitance		7.7		pF				
E_{oss}	C_{oss} stored energy		57		μJ				
Q_g	Total gate charge		135		nC	$V_{DS}=800\text{V}, I_D=40\text{A},$ $V_{GS}=-3\text{ to }18\text{V}$	Fig. 18		
Q_{gs}	Gate-source charge		36.8		nC				
Q_{gd}	Gate-drain charge		45.3		nC				
R_g	Gate input resistance		2.3		Ω				
E_{ON}	Turn-on switching energy		856.6		μJ	$V_{DS}=800\text{V}, I_D=40\text{A},$ $V_{GS}=-3.5\text{ to }18\text{V},$ $R_{G(\text{ext})}=3.3\Omega,$ $L=200\mu\text{H}$ $T_J=25^\circ\text{C}$	Fig. 19, 20		
E_{OFF}	Turn-off switching energy		118.0		μJ				
$t_{d(on)}$	Turn-on delay time		15.4		ns				
t_r	Rise time		24.6						
$t_{d(off)}$	Turn-off delay time		28.6						
t_f	Fall time		13.6						

Reverse Diode Characteristics ($T_c=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Value			Unit	Test Conditions	Note
		Min.	Typ.	Max.			
V_{SD}	Diode forward voltage		4.2		V	$I_{SD}=30\text{A}, V_{GS}=0\text{V}$	Fig. 10, 11, 12
			4.0		V	$I_{SD}=30\text{A}, V_{GS}=0\text{V},$ $T_J=175^\circ\text{C}$	
t_{rr}	Reverse recovery time		54.8		ns	$V_{GS}=-3.5\text{V}/+18\text{V},$ $I_{SD}=40\text{A}, V_R=800\text{V},$ $R_{G(\text{ext})}=13\Omega$ $L=200\mu\text{H}$ $di/dt=3000\text{A}/\mu\text{s}$	
Q_{rr}	Reverse recovery charge		470.7		nC		
I_{RRM}	Peak reverse recovery current		20.3		A		

Typical Performance (curves)

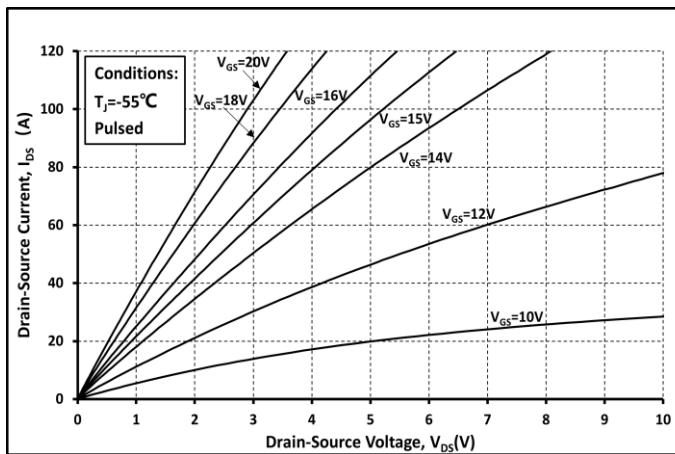


Fig. 1 Output Curve @ $T_j = -55^\circ\text{C}$

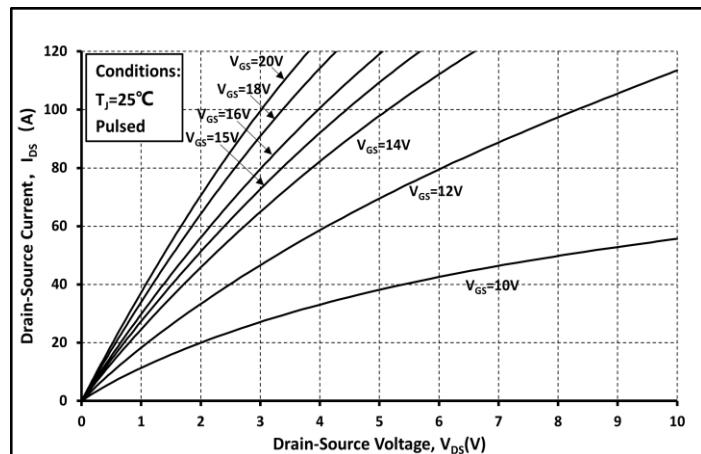


Fig. 2 Output Curve @ $T_j = 25^\circ\text{C}$

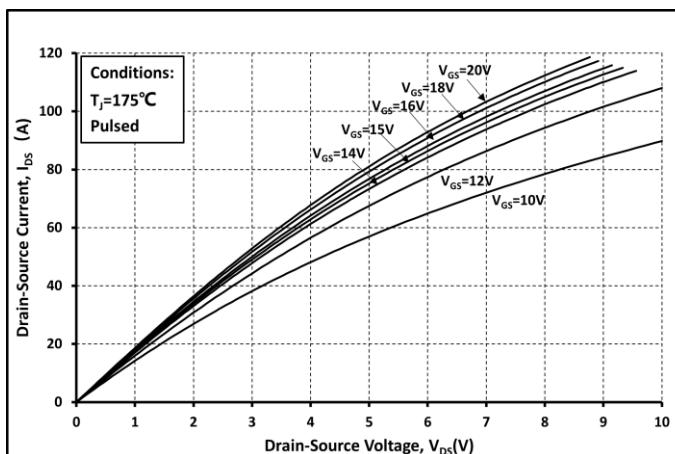


Fig. 3 Output Curve @ $T_j = 175^\circ\text{C}$

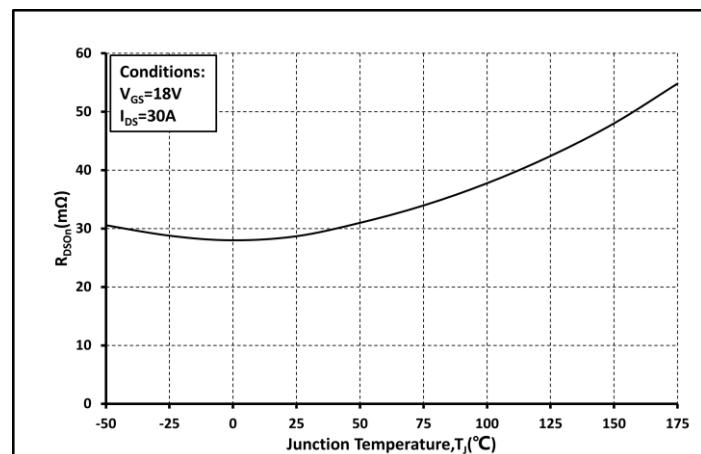


Fig. 4 Ron vs. Temperature

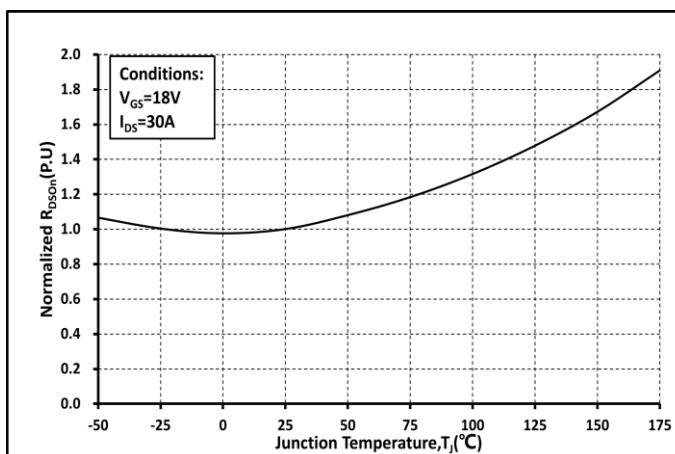


Fig. 5 Normalized Ron vs. Temperature

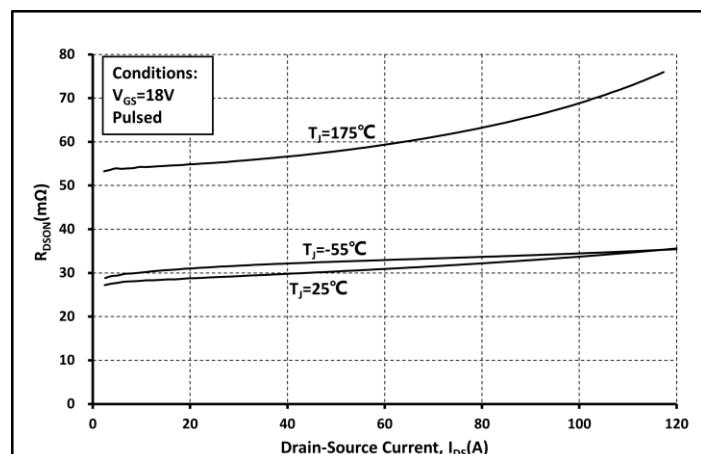


Fig. 6 Ron vs. I_{DS} @ Various Temperature

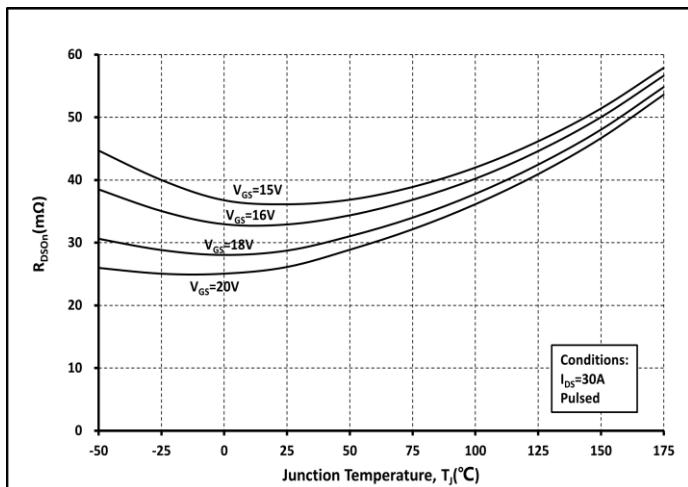


Fig. 7 Ron vs. Temperature @ Various V_{GS}

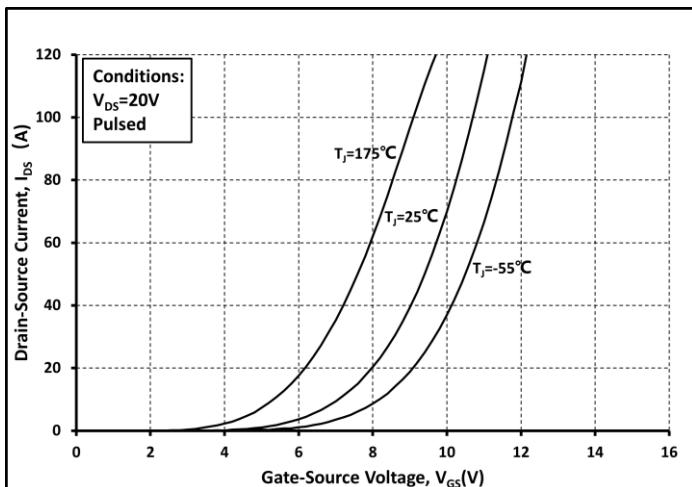


Fig. 8 Transfer Curves @ Various Temperature

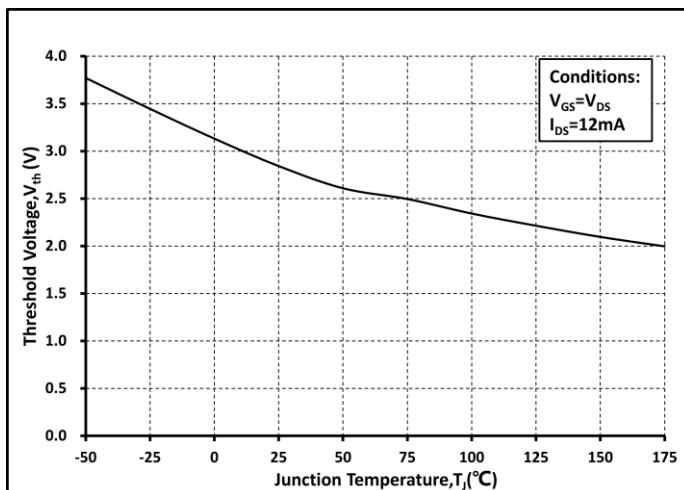


Fig. 9 Threshold Voltage vs. Temperature

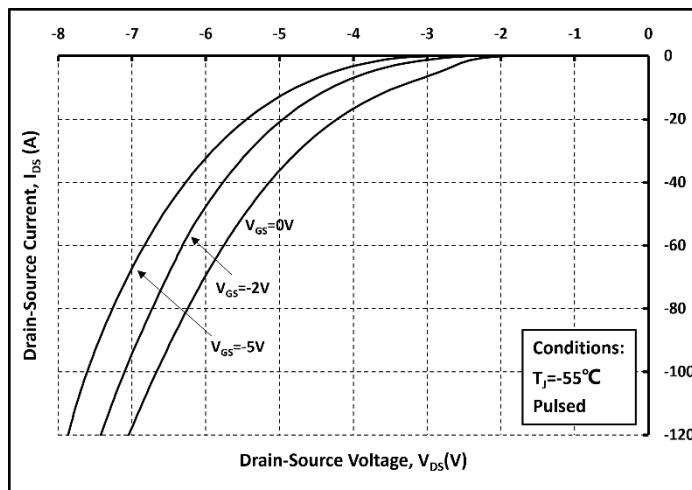


Fig. 10 Body Diode curves @ $T_J = -55^\circ\text{C}$

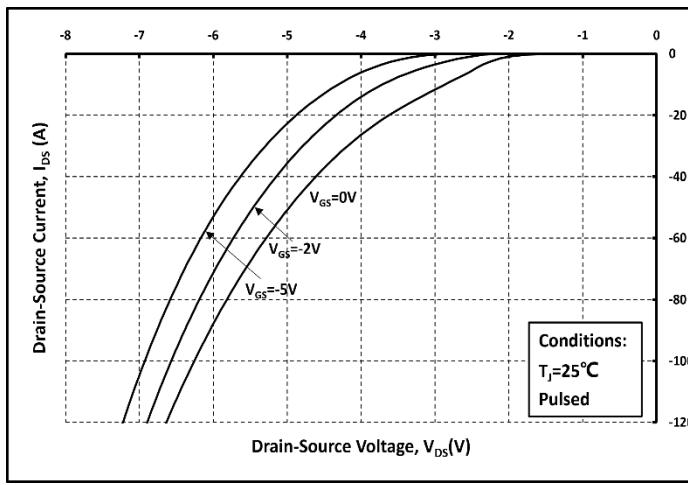


Fig. 11 Body Diode curves @ $T_J = 25^\circ\text{C}$

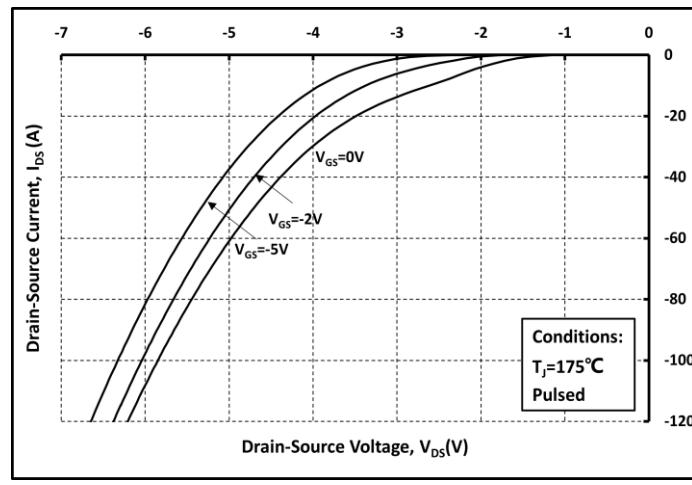


Fig. 12 Body Diode curves @ $T_J = 175^\circ\text{C}$

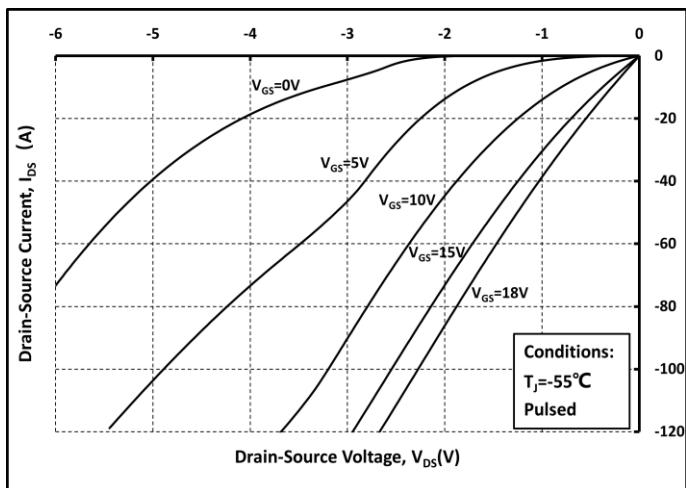


Fig. 13 3rd Quadrant curves @ $T_j = -55^\circ\text{C}$

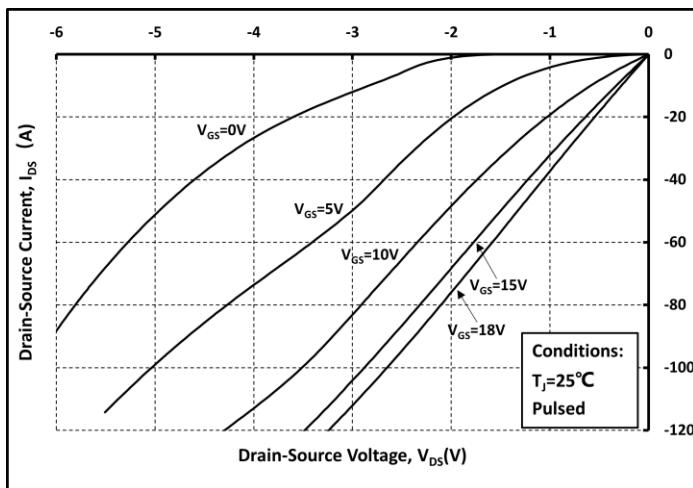


Fig. 14 3rd Quadrant curves @ $T_j = 25^\circ\text{C}$

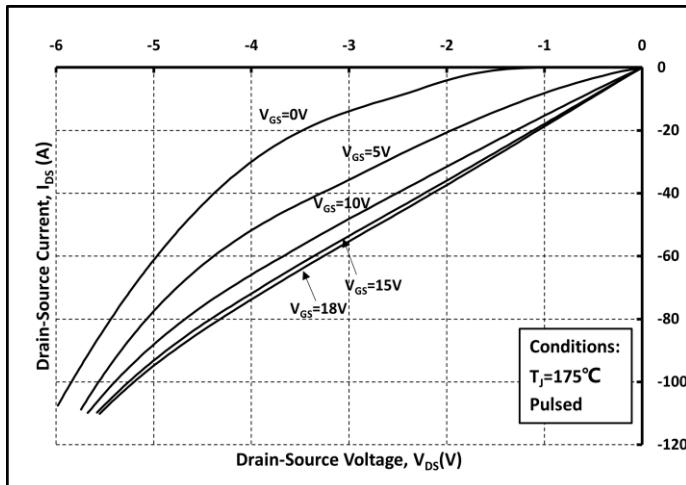


Fig. 15 3rd Quadrant curves @ $T_j = 175^\circ\text{C}$

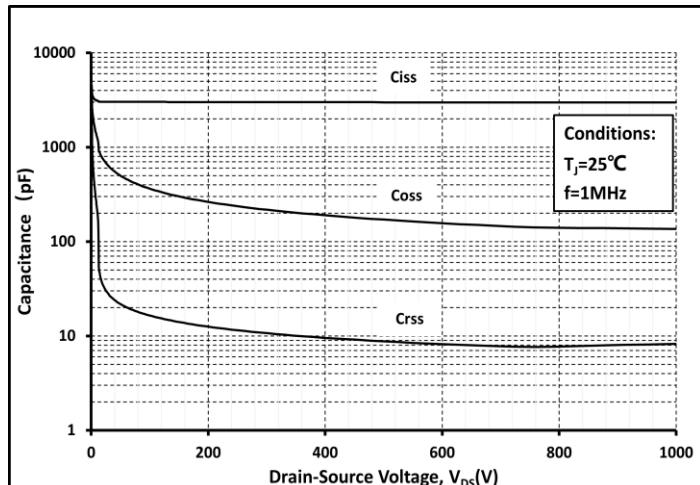


Fig. 16 Capacitance vs. V_{DS}

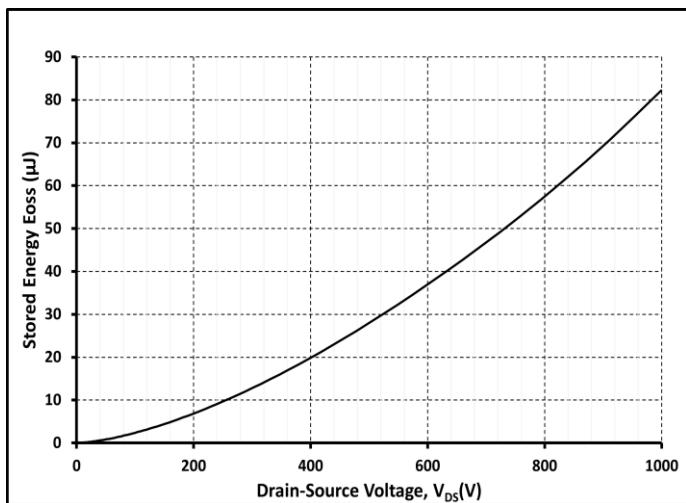


Fig. 17 Output Capacitor Stored Energy

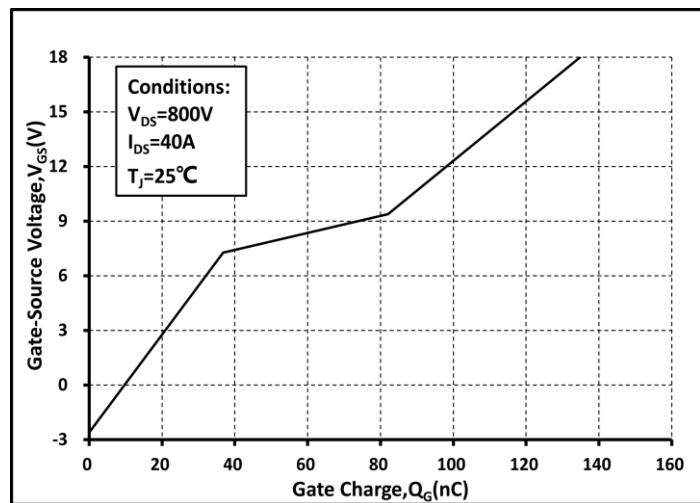


Fig. 18 Gate Charge Characteristics

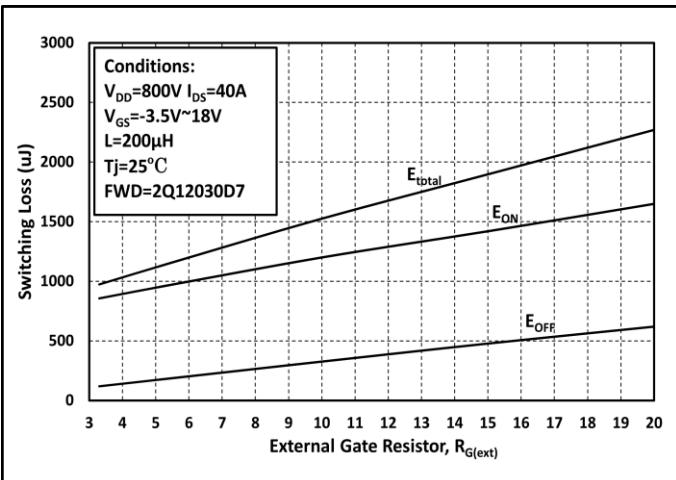


Fig. 19 Switching Energy vs. $R_{G(\text{ext})}$

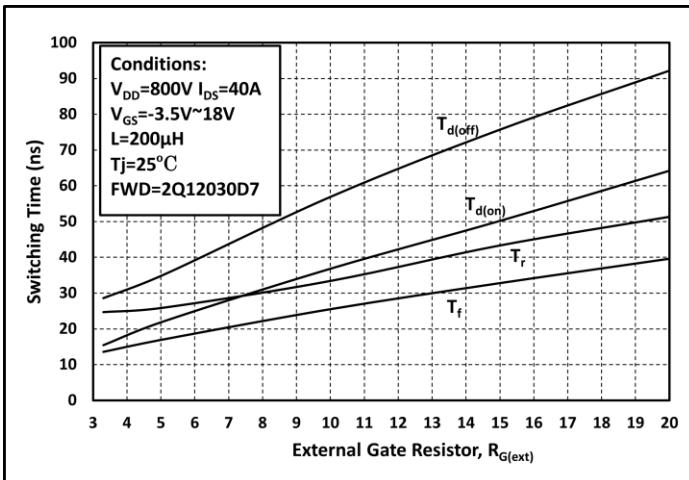


Fig. 20 Switching Times vs. $R_{G(\text{ext})}$

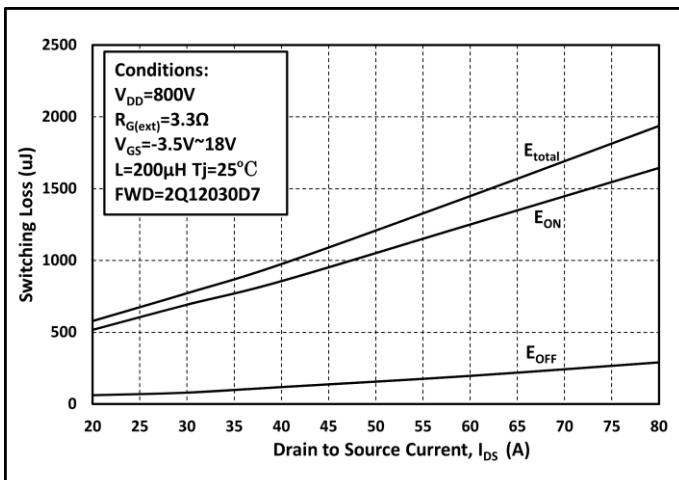


Fig. 21 Switching Energy vs. I_{DS}

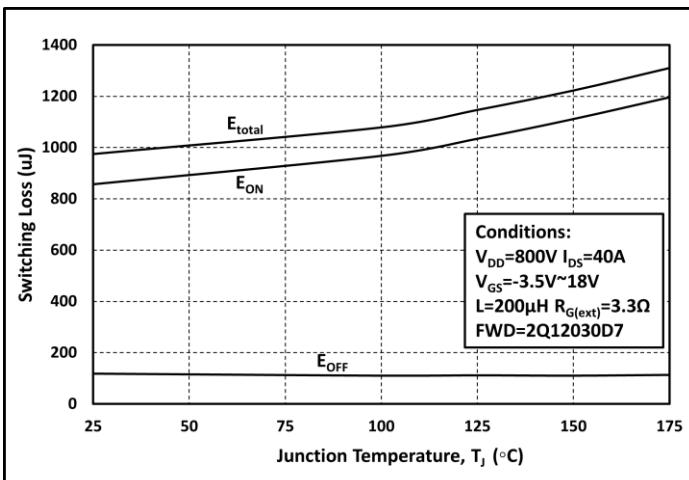


Fig. 22 Switching Energy vs. Temperature

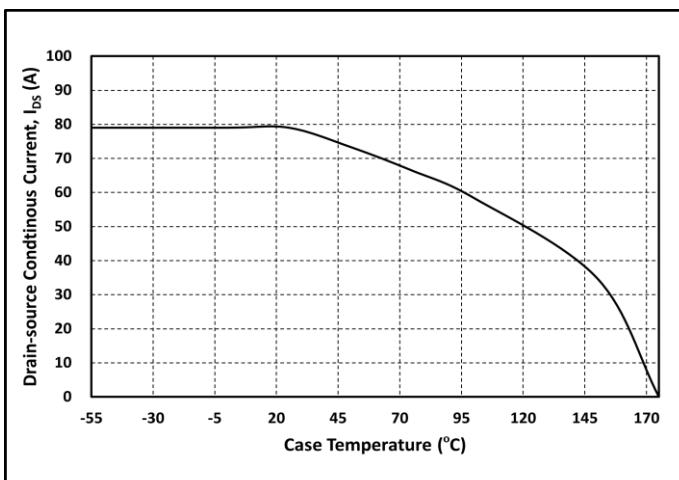


Fig. 23 Continuous Drain Current vs. Case Temperature

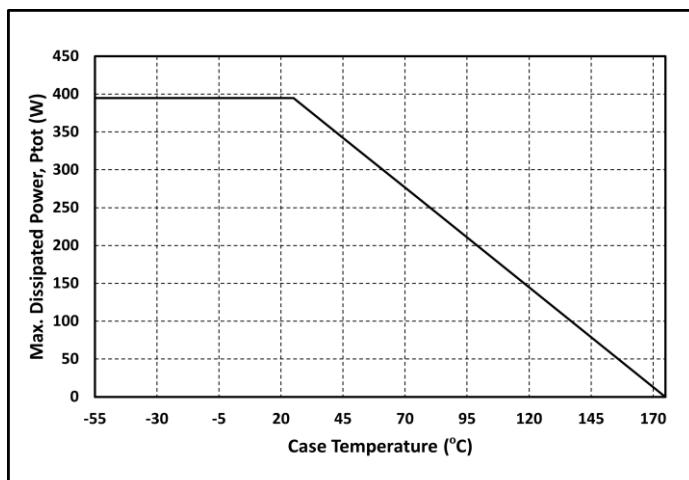


Fig. 24 Max. Power Dissipation Derating vs. Case Temperature

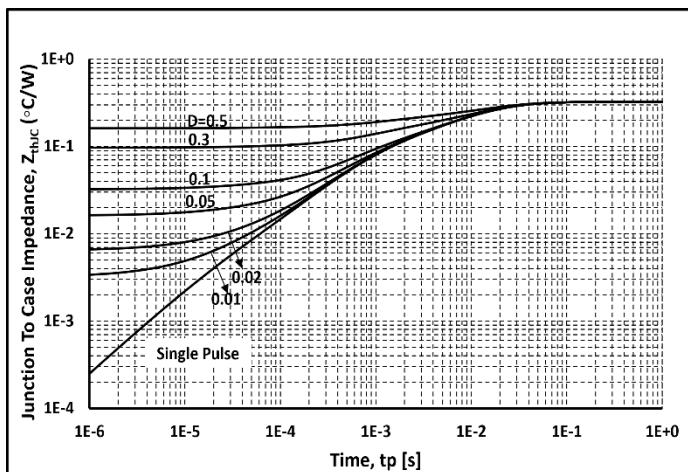


Fig. 25 Thermal impedance

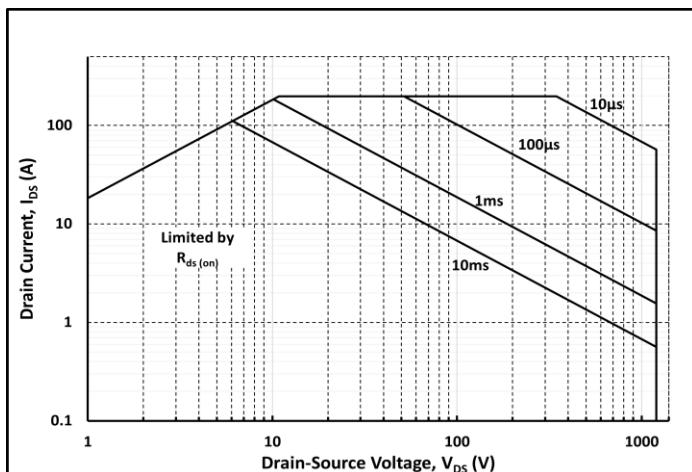
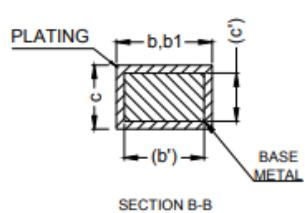
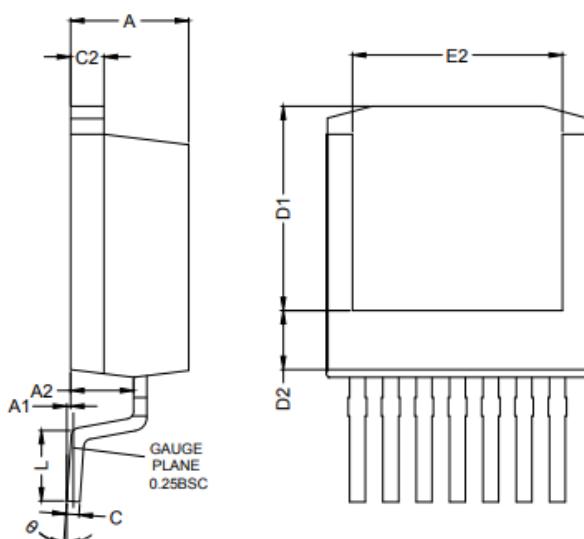
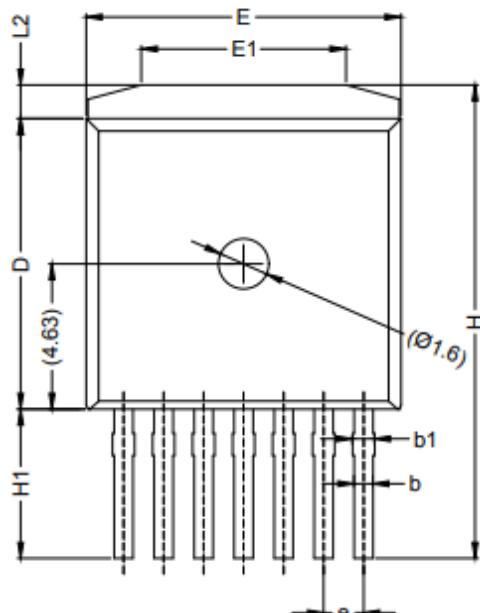


Fig. 26 Safe Operating Area

Package Dimensions



Items	Min	Max
A	4.30	4.70
A1	-	0.25
A2	2.20	2.60
b	0.52	0.72
b'	0.50	0.70
b1	0.60	0.80
c	0.42	0.62
c'	0.40	0.60
c2	1.07	1.47
D	9.05	9.45
D1	7.58	7.98
D2	2.05	2.45
e	1.27 BSC	
E	9.80	10.20
E1	6.30	6.70
E2	7.80	8.20
L	2.48	2.88
L2	0.87	1.27
H	14.87	15.27
H1	4.55	4.95
θ	0°	8°

Note:

1. Package Reference: JEDEC TO263, Variation AD
2. All Dimensions are in mm
3. Subject to Change Without Notice